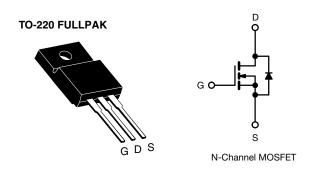
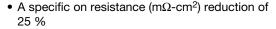
Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	V _{GS} = 10 V 0.084			
Q _g max. (nC)	134			
Q _{gs} (nC)	16			
Q _{gd} (nC)	48			
Configuration	Single			

FEATURES





- Low figure-of-merit (FOM) Ron x Qq
- Low input capacitance (C_{iss})
- · Reduced switching and conduction losses
- Ultra low gate charge (Qq)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	TO-220 FULLPAK
Lead (Pb)-free and halogen-free	SiHF35N60EF-GE3

ABSOLUTE MAXIMUM RATINGS (T _C	= 25 °C, un	less otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Drain-source voltage			V_{DS}	600	V
Gate-source voltage			V_{GS}	± 30	v
Continuous drain surrent (T = 150 °C) e	\/ at 10 \/	T _C = 25 °C	1	32	
Continuous drain current (T _J = 150 °C) $^{\rm e}$ $V_{\rm GS}$ at 10 V $\frac{T_{\rm C} = 25 ~^{\rm o}C}{T_{\rm C} = 100 ~^{\rm o}C}$			ID	20	Α
Pulsed drain current ^a			I _{DM}	80	
Linear derating factor				2.0	W/°C
Single pulse avalanche energy b			E _{AS}	298	mJ
Maximum power dissipation			P_{D}	39	W
Operating junction and storage temperature range			T _J , T _{stg}	-55 to +150	°C
Drain-source voltage slope T _J = 125 °C			dv/dt	100	1//20
Reverse diode dv/dt ^d				50	- V/ns
Soldering recommendations (peak temperature) c	For	10 s		260	°C
Mounting torque M3 screw			0.6	Nm	

- a. Repetitive rating; pulse width limited by maximum junction temperature
- b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 4.6 A
- c. 1.6 mm from case
- d. $I_{SD} = 17$ A, di/dt = 300 A/ μ s, starting $T_J = 25$ °C
- e. Limited by maximum junction temperature



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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R_{thJA}	-	65	°C/W
Maximum junction-to-case (drain)	R_{thJC}	-	3.2	C/VV

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	600	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 10 mA	-	0.66	-	V/°C
Gate-source threshold voltage (N)	V _{GS(th)}		· V _{GS} , I _D = 250 μA	2.0	-	4.0	V
		,	V _{GS} = ± 20 V	-	-	± 100	nA
Gate-source leakage	I _{GSS}	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 1	μA
Zana mata walta na aluain awanant	_	V _{DS} =	V _{DS} = 480 V, V _{GS} = 0 V		-	1	
Zero gate voltage drain current	I _{DSS}	V _{DS} = 480 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	500	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 17 A	-	0.084	0.097	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 30 V, I _D = 17 A	-	8	-	S
Dynamic							
Input capacitance	C _{iss}		$V_{GS} = 0 V$,	-	2568	-	
Output capacitance	C _{oss}	,	V _{DS} = 100 V,	-	113	-	
Reverse transfer capacitance	C _{rss}		f = 1 MHz	-	7	-	
Effective output capacitance, energy related ^a	C _{o(er)}	V _{DS} = 0 V to 480 V, V _{GS} = 0 V		-	81	-	pF
Effective output capacitance, time related ^b	C _{o(tr)}			-	421	-	
Total gate charge	Qg			-	89	134	
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$I_D = 17 \text{ A}, V_{DS} = 480 \text{ V}$	-	16	-	nC
Gate-drain charge	Q _{gd}			-	48	-	
Turn-on delay time	t _{d(on)}			-	28	56	
Rise time	t _r	V _{DD} = 480 V, I _D = 17 A,		-	85	170	200
Turn-off delay time	t _{d(off)}	V _{GS} =	$= 10 \text{ V, R}_{g} = 9.1 \Omega$	-	96	192	ns
Fall time	t _f			-	61	122	
Gate input resistance	R _g	f = 1	MHz, open drain	0.2	0.5	1.0	Ω
Drain-Source Body Diode Characteristic	es						
Continuous source-drain diode current	I _S	MOSFET sym showing the		-	-	32	
Pulsed diode forward current	I _{SM}	integral reverse p - n junction diode		-	-	80	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 17 A, V _{GS} = 0 V		-	-	1.2	V
Reverse recovery time	t _{rr}	-		-	150	300	ns
Reverse recovery charge	Q _{rr}		$5 ^{\circ}\text{C}, I_F = I_S = 17 \text{A},$	-	1.1	2.2	μC
Reverse recovery current	I _{RRM}	di/dt = 100 A/μs, V _R = 400 V		-	14	-	A

- a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS}



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

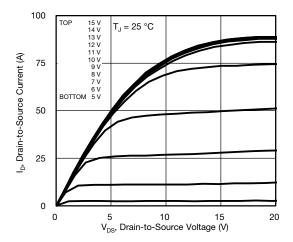


Fig. 1 - Typical Output Characteristics

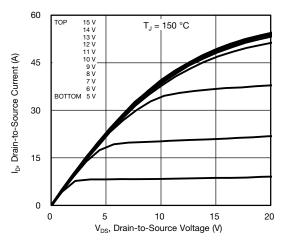


Fig. 2 - Typical Output Characteristics

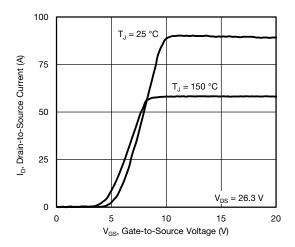


Fig. 3 - Typical Transfer Characteristics

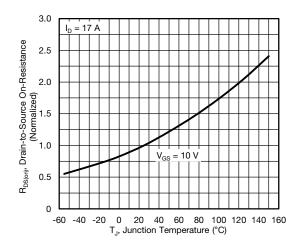


Fig. 4 - Normalized On-Resistance vs. Temperature

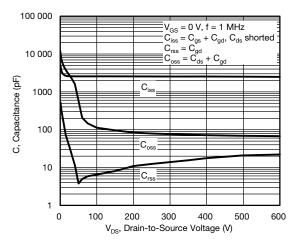


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

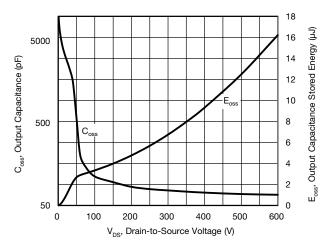


Fig. 6 - Coss and Eoss vs. VDS



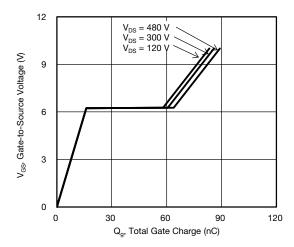


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

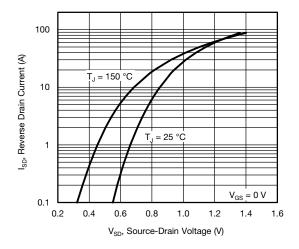


Fig. 8 - Typical Source-Drain Diode Forward Voltage

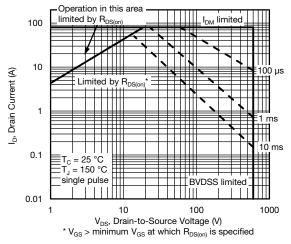


Fig. 9 - Maximum Safe Operating Area

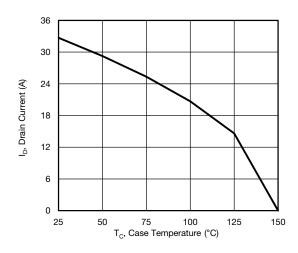


Fig. 10 - Maximum Drain Current vs. Case Temperature

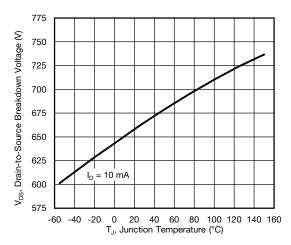


Fig. 11 - Temperature vs. Drain-to-Source Voltage



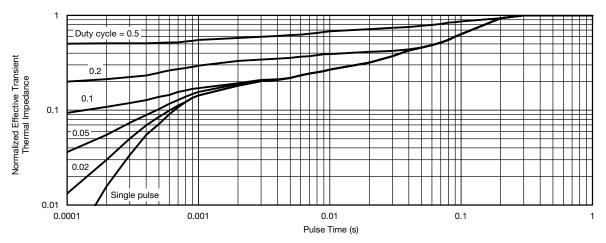


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

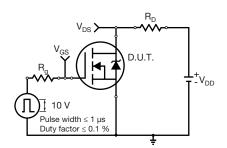


Fig. 13 - Switching Time Test Circuit

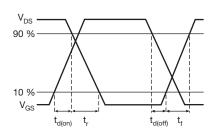


Fig. 14 - Switching Time Waveforms

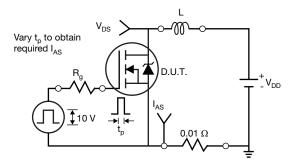


Fig. 15 - Unclamped Inductive Test Circuit

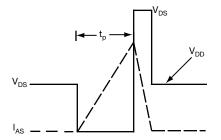


Fig. 16 - Unclamped Inductive Waveforms

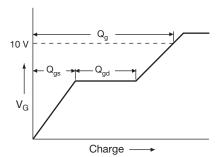


Fig. 17 - Basic Gate Charge Waveform

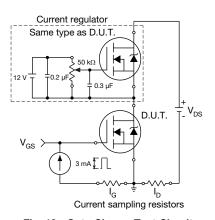
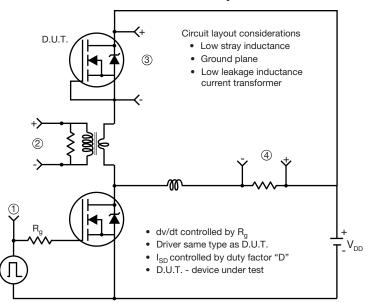


Fig. 18 - Gate Charge Test Circuit



Peak Diode Recovery dv/dt Test Circuit



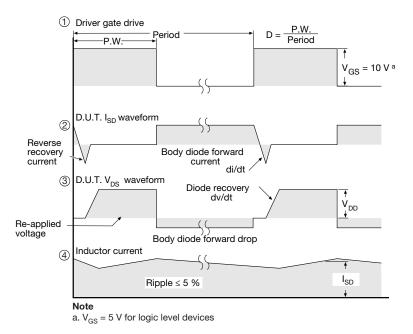


Fig. 19 - For N-Channel

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon

SiHF35N60EF



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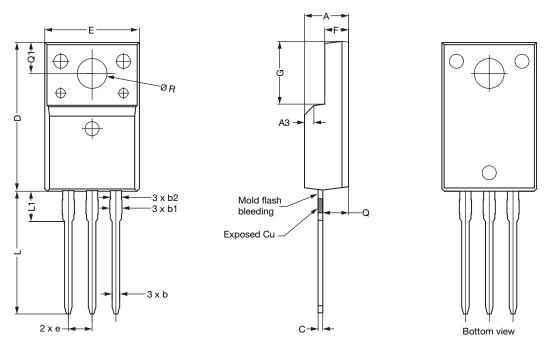
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Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?92110.

www.vishay.com Vishay Siliconix

TO-220 FULLPAK (High Voltage)

OPTION 1: FACILITY CODE = 9

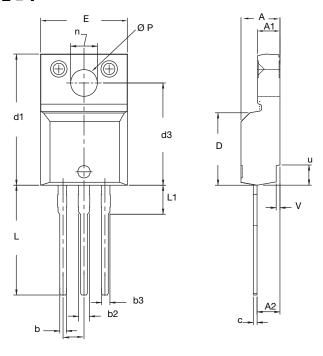


	MILLIMETERS		
DIM.	MIN.	NOM.	MAX.
Α	4.60	4.70	4.80
b	0.70	0.80	0.91
b1	1.20	1.30	1.47
b2	1.10	1.20	1.30
С	0.45	0.50	0.63
D	15.80	15.87	15.97
е		2.54 BSC	
E	10.00	10.10	10.30
F	2.44	2.54	2.64
G	6.50	6.70	6.90
L	12.90	13.10	13.30
L1	3.13	3.23	3.33
Q	2.65	2.75	2.85
Q1	3.20	3.30	3.40
ØR	3.08	3.18	3.28

- 1. To be used only for process drawing
- 2. These dimensions apply to all TO-220 FULLPAK leadframe versions 3 leads
- 3. All critical dimensions should C meet $C_{pk} > 1.33$
- 4. All dimensions include burrs and plating thickness
- 5. No chipping or package damage
- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



OPTION 2: FACILITY CODE = Y



MILLIM		IETERS	INC	NCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	
Α	4.570	4.830	0.180	0.190	
A1	2.570	2.830	0.101	0.111	
A2	2.510	2.850	0.099	0.112	
b	0.622	0.890	0.024	0.035	
b2	1.229	1.400	0.048	0.055	
b3	1.229	1.400	0.048	0.055	
С	0.440	0.629	0.017	0.025	
D	8.650	9.800	0.341	0.386	
d1	15.88	16.120	0.622	0.635	
d3	12.300	12.920	0.484	0.509	
E	10.360	10.630	0.408	0.419	
е	2.54	BSC	0.100 BSC		
L	13.200	13.730	0.520	0.541	
L1	3.100	3.500	0.122	0.138	
n	6.050	6.150	0.238	0.242	
ØΡ	3.050	3.450	0.120	0.136	
u	2.400	2.500	0.094	0.098	
V	0.400	0.500	0.016	0.020	

ECN: E19-0180-Rev. D, 08-Apr-2019

DWG: 5972

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- 3. All critical dimensions should C meet $C_{pk} > 1.33$
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- 6. Facility code will be the 1st character located at the 2nd row of the unit marking



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Vishay

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